


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	EMBEDDED PROCESSING/26/16389	
1.3 Title of PCN	ST Shenzhen (china) additional source for STM32F2x and STM32F4x listed products in LQFP 14x14 packages	
1.4 Product Category	STM32F205x, STM32F207x, STM32F215x, STM32F217x, STM32F405x, STM32F407x, STM32F415x, STM32F417x, STM32F427x, STM32F429x, STM32F437x and STM32F439x	
1.5 Issue date	2026-06-30	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Patrick AIDOUNE
2.1.2 Marketing Manager	Marie TOURNUT
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	ST Shenzhen (China)

4. Description of change

	Old	New
4.1 Description	<p>Current assembly sites :</p> <ul style="list-style-type: none"> - AMKOR ATP (Philippine) Gold wire, - AMKOR ATP (Philippine) Copper Palladium wire, - ASE Kaohsiung (Taiwan) Gold wire , - ASE Kaohsiung (Taiwan) Copper Palladium wire , - MUAR (Malaysia) Silver wire. <p>You may refer to 16389_Additional information.pdf document for further details.</p>	<p>Current assembly sites:</p> <ul style="list-style-type: none"> - AMKOR ATP (Philippine) Gold wire, - AMKOR ATP (Philippine) Copper Palladium wire, - ASE Kaohsiung (Taiwan) Gold wire , - ASE Kaohsiung (Taiwan) Copper Palladium wire , - MUAR (Malaysia) Silver wire , - ST Shenzhen (China) Copper Alloy wire - additional site for extended capacity
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact on Form, Fit or Function	

5. Reason / motivation for change

5.1 Motivation	Due to the success on the market of STM32 devices, ST General Purpose and Automotive Microcontrollers division decided to qualify an additional back-end site to maintain state of the art service level to our customers thanks to extra capacity.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	<p>Change is visible on the marking</p> <ul style="list-style-type: none"> - Back-End Assembly Site code: <ul style="list-style-type: none"> • 7B : AMKOR ATP (Philippines) • AA : ASE KaoHsiung (Taiwan) • 99 : ST Muar (Malaysia) • GK : ST Shenzhen (China) New Assembly site <p>Please refer to PCN 16389_Additional information.pdf document for further details.</p>
------------------------	---

7. Timing / schedule

7.1 Date of qualification results	2026-09-25
--	------------

7.2 Intended start of delivery	2026-09-30
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	16389 MDRF-GPAM-RER2613 STShz add srce STM32F2x-F4x LQ14-full china supply chain - Rel PLAN.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2026-06-30

9. Attachments (additional documentations)

16389 Public product.pdf
16389 MDRF-GPAM-RER2613 STShz add srce STM32F2x-F4x LQ14-full china supply chain - Rel PLAN.pdf
16389 _Additional information.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32F205VBT6	
	STM32F205VCT6	
	STM32F205VCT6TR	
	STM32F205VCT7	
	STM32F205VCT7TR	
	STM32F205VET6	
	STM32F205VET6TR	
	STM32F205VET7	
	STM32F205VET7TR	
	STM32F205VFT6	
	STM32F205VFT6TR	
	STM32F205VGT6	
	STM32F205VGT6TR	
	STM32F205VGT6V	
	STM32F205VGT6W	
	STM32F205VGT7	
	STM32F207VCT6	
	STM32F207VCT6TR	
	STM32F207VCT7	
	STM32F207VET6	
	STM32F207VET6TR	
	STM32F207VFT6	
	STM32F207VGT6	
	STM32F207VGT6TR	
	STM32F207VGT7	
	STM32F215VET6	
	STM32F215VGT6	
	STM32F215VGT7	
	STM32F217VET6	
	STM32F217VET6TR	
	STM32F217VGT6	
	STM32F217VGT6TR	
	STM32F405VGT6	
	STM32F405VGT6TR	
	STM32F405VGT6V	
	STM32F405VGT6W	

	STM32F405VGT7	
	STM32F405VGT7TR	
	STM32F407VET6	
	STM32F407VET6TR	
	STM32F407VGT6	
	STM32F407VGT6TR	
	STM32F407VGT7	
	STM32F407VGT7TR	
	STM32F415VGT6	
	STM32F415VGT6TR	
	STM32F417VET6	
	STM32F417VGT6	
	STM32F417VGT6TR	
	STM32F417VGT7	
	STM32F427VGT6	
	STM32F427VGT6TR	
	STM32F427VGT7	
	STM32F427VIT6	
	STM32F427VIT6TR	
	STM32F427VIT7TR	
	STM32F429VET6	
	STM32F429VET6TR	
	STM32F429VGT6	
	STM32F429VGT6TR	
	STM32F429VIT6	
	STM32F429VIT6TR	
	STM32F437VGT6	
	STM32F437VGT7TR	
	STM32F437VIT6	
	STM32F437VIT6TR	
	STM32F437VIT7	
	STM32F439VGT6	
	STM32F439VIT6	

IMPORTANT NOTICE – PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics – All rights reserved